

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-12832BE-1A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS			
Product Mgr Doc. Control Electr. Eng			
Bazile	Anthony	Rekha	
Peter	Perkins	Mani	



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	12 May 08			First Issue	
В	28 Nov 12	27	10	Add chapter 10 supported accessories	

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1 MAIN FEATURES

ITEM	CONTENTS
Display Format	128 x 32 Dots
Overall Dimensions	62.00 x 24.00 x 2.00 mm
Colour	Monochrome (Light Blue)
Active Area	55.02 x 13.10 mm
Viewing Area	57.02 x 15.1 mm
Display Mode	Passive Matrix (2.23")
Driving Method	1/32 duty
Driver IC	SSD1305
Operating temperature	-30 ~ +70
Storage temperature	-40 ~ +80

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2 MECHANICAL SPECIFICATION

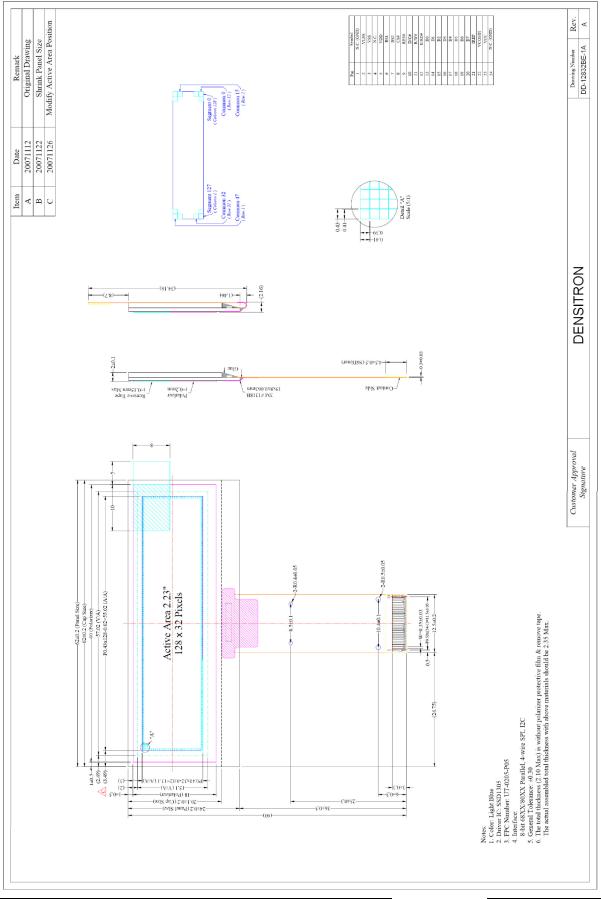
2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	128 x 32 Dots	Dots
Overall Dimensions	62.00 x 24.00 x 2.00	mm
Viewing Area	57.02 x 15.10	mm
Active Area	55.02 x 13.10	mm
Dot Size	0.41 x 0.39	mm
Dot Pitch	0.43 x 0.41	mm
Weight	5.80	g
IC Controller/Driver	SSD1305	

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2.2 MECHANICAL DRAWING



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3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min	Max	Unit	Note
Supply Voltage for logic	$V_{ m DD}$	-0.3	4.0	V	Note 1 2
Supply voltage for Display	Vcc	0	15	V	Note 1, 2
Operating Temperature	Тор	-30	70	°C	
Storage Temperature	Tst	-40	80	°C	
Static Electricity	Be sure that you are grounded when handling displays.			g displays.	

Note 1: All the above voltages are on the basis of "VSS=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.



3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V_{DD}		2.4	2.8	3.5	V
Supply Voltage for Display	Vcc	Note 3	12	12.5	13.0	V
High Level Input	V_{IH}		$0.8xV_{DD}$	-	V_{DD}	V
Low Level Input	V _{IL}	IOUT=0.1mA,	0	-	0.2 x VDD	V
High Level Output	V_{OH}	3.3MHz	0.9 x V DD	-	VDD	V
Low Level Output	V_{OL}		0	-	0.1 x V _{DD}	V
Operating symment for Van	Idd	Note 4	-	180	300	^
Operating current for VDD	IDD	Note 5	-	180	300	μΑ
On anoting assument for V	T	Note 4	-	20	25	A
Operating current for Vcc	Icc	Note 5	-	28	35	mA
Sleep mode current for VDD	Idd Sleep		-	1	5	μΑ
Sleep mode current for Vcc	ICC SLEEP	C D: 1	-	1	5	μΑ

Note 3 Brigthness (L_{br}) and Supply Voltage for Display (V_{CC}) are subject to the change of the panel characteristics and the customers request

Note 4 $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 50% display area turned on.

Note 5 $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 100% display area turned on.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	Function	
1	N.C.(GND)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.	
2	VLSS	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally	
3	VSS	Ground of OEL System This is a ground pin. It also acts as a reference for the logic pins, the OEL driving voltages, and the analog circuits. It must be connected to external ground.	
4	N.C.	No Connection	
5	VDD	Power Supply for Logic Circuit This is a voltage supply pin. It must be connected to external source.	
6	BS1	Communicating Protocol Select	
7	BS2	These pins are MCU interface selection input. See the following table: 68XX-parallel 80XX-parallel Serial I2C BS1 0 1 0 1 BS2 1 1 0 0	
8	CS#	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.	
9	RES#	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.	
10	D/C#	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.	
11	R/W#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.	
12	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.	
13~20	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is	

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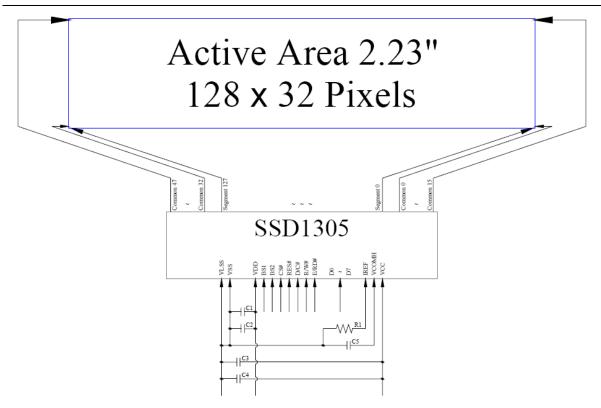
		selected, D2 & D1 should be tied together and serve as SDAout &SDAin in application and D0 is the serial clock input SCL.
21	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA
Voltage Output High Level for COM signal This pin is the input pin for the voltage output high		Voltage Output High Level for COM signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
23	VCC	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. It must be supplied externally.
24	N.C.(GND)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

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3.4 BLOCK DIAGRAM



MCU Interface Selection: BS1 and BS2

Pins connected to MCU interface: D7~D0, E/RD#, R/W#, D/C#, RES# and CS#.

C1, C3: 0.1μF C2: 4.7μF C4: 10μF

C5: 4.7µF/25V Tantalum Capacitor

R1: $910 \text{ k}\Omega$, R1 = (Voltage at IREF – VSS) / IREF

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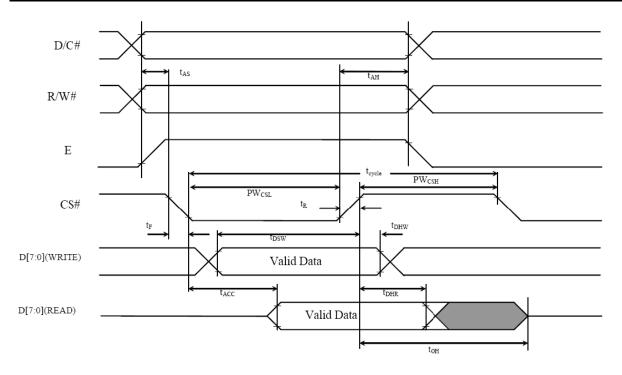
3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

3.5.1.1 68XX-Series MPU Parallel Interface Timing Characteristics

 V_{DD} - $V_{SS} = 2.4V$ to 3.5V, $Ta=25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	System Cycle Time	300	-	ns
tAS	Address Setup Time	0	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	7	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
PWCSL	Chip Select Low Pulse Width (Read) Chip Select	120		
PWCSL	Low Pulse width (Write)	60] -	ns
DWGGH	Chip Select High Pulse Width (Read) Chip Select	60		
PWCSH	High Pulse Width (Write)	60	-	ns
tR	Rise Time		15	ns
tF	Fall Time	-	15	ns



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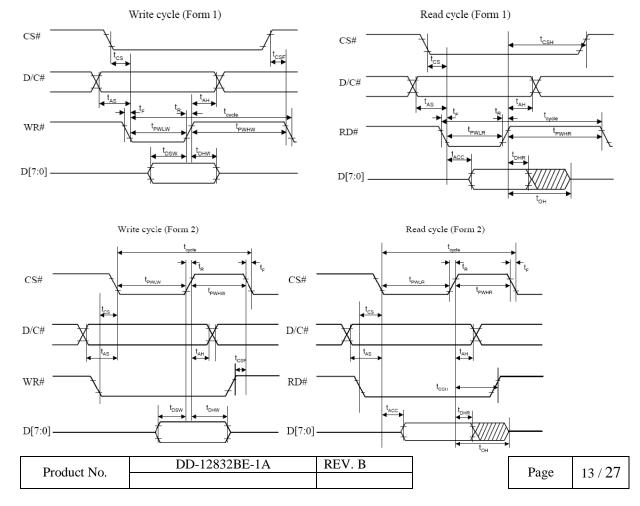
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3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics

 $V_{DD}-V_{SS} = 2.4V \text{ to } 3.5V, Ta=25^{\circ}C$

Symbol	Description	$\frac{1-2.4 \text{ V to 3}}{\text{Min}}$	Max	Unit
tcycle	Clock Cycle Time	300	-	ns
tAS	Address Setup Time	10	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	7	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
tPWLR	Read Low Time	120	-	ns
tPWLW	Write Low Time	60	-	ns
tPWHR	Read High Time	60	-	ns
tPWHW	Write High Time	60	-	ns
tCS	Chip Select Setup Time	0	-	ns
tCSH	Chip Select Hold Time to Read Signal	0	-	ns
tCSF	Chip Select Hold Time	20	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns



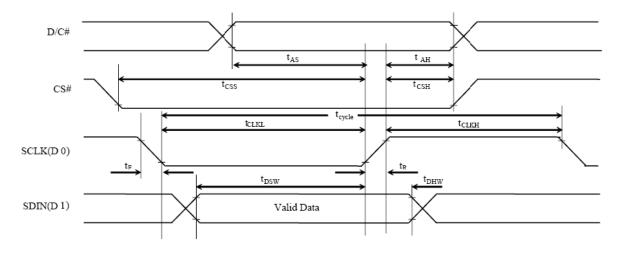
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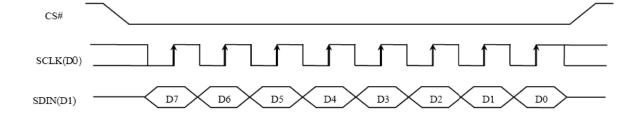


3.5.1.3 Serial Interface Timing Characteristics

 $V_{DD}-V_{SS} = 2.4V$ to 3.5V, $Ta=25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	250	-	ns
tAS	Address Setup Time	150	-	ns
tAH	Address Hold Time	150	-	ns
tCSS	Chip Select Setup Time	120	-	ns
tCSH	Chip Select Hold Time	60	-	ns
tDSW	Write Data Setup Time	50	-	ns
tDHW	Write Data Hold Time	15	-	ns
tCLKL	Serial Clock Low Time	100	-	ns
tCLKH	Serial Clock High Time	100	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns





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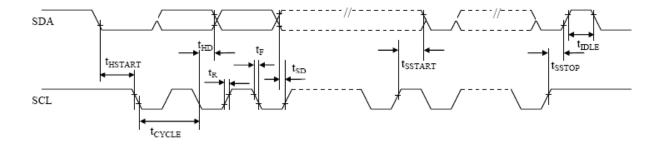
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3.5.1.4 I²C Interface Timing Characteristics

 $V_{DD}-V_{SS} = 2.4V \text{ to } 3.5V, Ta=25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	2.5	-	us
tHSTART	Start Condition Hold Time	0.6	-	us
(III)	Data Hold Time (for "SDAOUT" Pin) Data	0		
tHD	Hold Time (for "SDAIN" Pin)	300	-	ns
tSD	Data Setup Time	100	-	ns
tSSTART	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	us
tSSTOP	Stop Condition Setup Time	0.6	-	us
tR	Rise Time for Data and Clock Pin		300	ns
tF	Fall Time for Data and Clock Pin		300	ns
tIDLE	Idle Time before a New Transmission can Start	1.3	-	us



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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness(White)	L_{br}	With Polarizer (Note 3)	100	120	1	cd/m ²
C.I.E.(Blue)	(X)	Without Polarizer	0.12	0.16	0.20	
C.I.E.(Blue)	(Y)	Without Folarizer	0.22	0.26	0.30	-
Dark Room Contrast	CR		-	>2000:1	-	-
Viewing Angle			>160	-	1	degree

Optical measurement taken at $V_{DD} = 2.8V$, $V_{CC} = 12.5V$. Software configuration follows Section 5.4 Initialization

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5 FUNCTIONAL SPECIFICATION

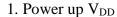
5.1 COMMANDS

Please refer to the Technical Manual for the SSD1305

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

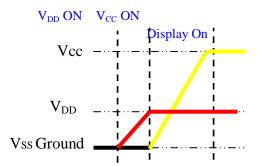
5.2.1 POWER UP SEQUENCE



- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5.Power up Vcc
- 6. Delay 100ms

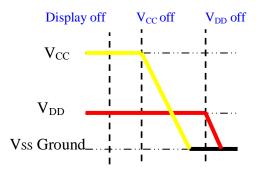
(when VDD is stable)

7. Send Display on command



5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{CC}
- 3. Delay 100ms (When V_{CC} reach 0 and panel is completely discharges)
- 4. Power down V_{DD}



5.3 RESET CIRCUIT

When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 132x64 Display mode
- 3. Normal segment and display data colume and row address mapping (SEG0 mapped to column address 00h and COM0 mapped to row address 00h)
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 80h
- 9. Normal display mode (Equivalent to A4h command)

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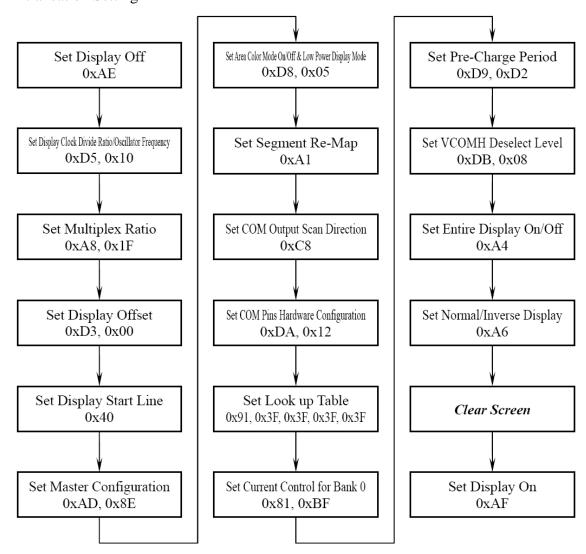
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5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example

<Initialisation Setting>



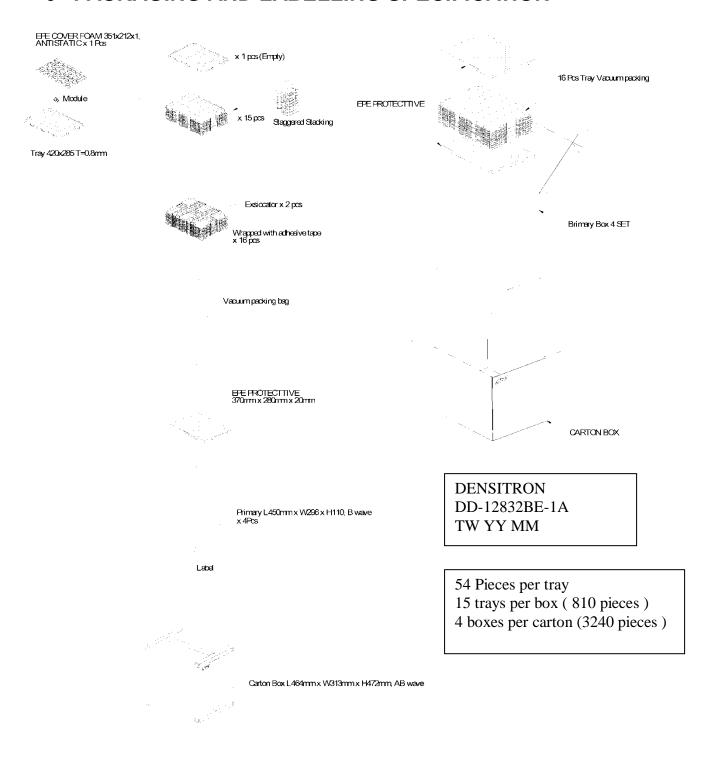
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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6 PACKAGING AND LABELLING SPECIFICATION



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

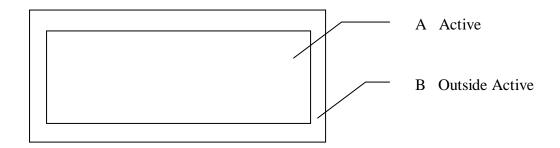
The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions:

Temperature: 23 ± 5 °C

Humidity: $55\pm15\%$ RH

Fluorescent lamp: 30 W

Distance between the Panel & Eyes of the Inspector: ≥ 30 cm

Distance between the Panel & the lamp: ≥50cm

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7.2.4 Standard of appearance inspection

Units: mm

Class	Item	Criteria				
Minor	Packing &	Outside & inside package Presence of product no., lot no., quantity				
Critical	Label			d with others and		
			d on the labe			
Major	Dimension	Product dime	ensions must	be according to sp	pecification and di	rawing
Major	Electrical	Product elec	trical charact	eristics must be ac	cording to specifi	cation
Critical	OLED Display	Missing lines, short circuits or wrong patterns on OLED display are not allowed				
Minor	Black spot, white spot,	Round type: $\emptyset = (X+Y)/2$	as per follow	ring drawing		
	dust			A	cceptable quantity	/
				Size	Zone A	Zone B
			<u> </u>	Ø<0.1	Any number	
			Y	0.1<Ø<0.2	3	A ny mumb an
		1 1	<u>-</u>	0.2<Ø<0.25	1	Any number
		X		0.25<Ø	0	
		Line type: as	s per followin		ole quantity	
		W	Length	Width	Zone A	Zone B
		1/2		W≤0.05	Any number	
			L≤2.0	W≤0.1	3	Any number
			L>2.0		0	
		L				
			Total accep	table quantity: 3		
Minor	Polariser	Scratch on p	rotective film	n is permitted		
	scratch	Scratch on p	olariser: sam	e as No. 1		
Minor	Polariser	$\emptyset = (X+Y)/2$				
	bubble	Acceptable quantity				
				Size	Zone A	Zone B
		1	<u>-</u>	Ø<0.5	Any number	Any number
			_Y	Ø>0.5	0	J
		X	•			

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Class	Item	Criteria		
Minor	Segment deformation	1b. Pin hole on dot matrix display	Acceptable Size $a,b<0.1$ $(a+b)/2\leq0.1$ $0.5<\varnothing<1.0$ Total acceptable	Any number Any number 3
		2. Segments / dots with different width	Accept a≥b a <b< td=""><td>table a/b≤4/3 a/b>4/3</td></b<>	table a/b≤4/3 a/b>4/3
		3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size $\emptyset \le 0.4$ $0.4 < \emptyset \le 1.0$ $1.0 < \emptyset \le 1.5$ $1.5 < \emptyset \le 2.0$ Total acceptable	Any number 5 3 2
Minor	Panel Chipping	$X \le 1/6$ Panel length $Y \le 1$ $Z \le T$		Z
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item	Criteria			
Minor	Contact Lead Twist	Not allowed		D. TVISTED LEAD	
Minor	Contact Lead Broken	Not allowed		A. BROKEN LEAD	
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit			
		Not allowed if bent extends horizontall more than 50% of its width	7		
Minor	Colour uniformity	Level of sample for approval set as limit sample			
Major	PCB ~	No unmelted solder paste should be present on PCB			
Critical		Cold solder joints, missing solder connections, or oxidation are not allowed			
Minor		No residue or solder balls on PCB are allowed			
Critical		Short circuits on components are not allowed			
Minor	Tray			Size	Quantity
	particles		On tray	Ø<0.2	Any number
			-	Ø>0.25 Ø≥0.25	4 2
	1	1	On display	∠∠U.∠J	

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment
High Temperature Operation	85°C, 500 hours	No abnormalities in function and appearance
Low Temperature Operation	-30°C, 500 hours	No abnormalities in function and appearance
High Temperature Storage	90°C, 500 hours	No abnormalities in function and appearance
Low Temperature Storage	-40°C, 500 hours	No abnormalities in function and appearance
High Temperature & High Humidity Storage	60°C, 90%RH, 500 hours	No abnormalities in function and appearance
Thermal Shock	100 cycle of -40°C ↔85°C 30 Mins dwell	No abnormalities in function and appearance

- The samples used for above tests do not include polarizer.
- No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23 ± 5 °C; $55\pm15\%$ RH

8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 10,000 hours under 120 cd/m² brightness and 50% Checkerboard, humidity (50% RH), and in area not exposed to direct sunlight.
2	End of lifetime is specified as 50% of initial brightness.

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9 HANDLING PRECAUTIONS

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}C \pm 10^{\circ}C$ and the humidity below 50% RH

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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10 SUPPORTED ACCESSORIES

10.1 DUO KIT

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC.

DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-12832BE-1A

10.2 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display. **Part number: PDT-N-12832BE-1A**

10.3 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system).

Part number: EVK-CONNECT-015

10.4 CONNECTOR

Type: ZIF connector

No. of connections	Pitch (mm)	Manufacturer	Manufacturer part no.	Distributor part no.
24	0.50	Omron	XF2M-2415-1A	Farnell/1112559 Digikey/ OR721CT-ND

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